

Hardware Specifications & Bill of Materials

Smart Bin Node Types

Type A: Basic Fill Monitoring Node

Use Case: Standard waste bins, recycling containers **Battery Life:** 6-12 months **Connectivity:** WiFi **Cost Target:** \$45-65

Core Components

ESP32-S3-WROOM-1 Module

CPU: Dual-core Xtensa LX7 @ 240MHz

RAM: 512KB SRAM + 2MB PSRAM

Flash: 8MB

WiFi: 802.11 b/g/n

Power: 3.3V, sleep mode 10µA

HC-SR04 Ultrasonic Sensor

Range: 2cm - 400cm

Accuracy: ±3mm

Operating Voltage: 5V

Current: 15mA

Trigger: 10µs TTL pulse

Power System

Battery: 2x 18650 Li-ion (3.7V, 3000mAh)

Solar Panel: 6V 2W polycrystalline

Charge Controller: TP4056 with protection

Voltage Regulator: AMS1117-3.3V

Detailed BOM

Component	Part Number	Qty	Unit Cost	Supplier	Notes
ESP32-S3 Module	ESP32-S3-WROOM-1-N8R2	1	\$8.50	Espressif	8MB Flash, 2MB PSRAM
Ultrasonic Sensor	HC-SR04	1	\$2.80	Generic	Waterproof version preferred
18650 Battery	INR18650-30Q	2	\$4.00	Samsung	3000mAh, high drain
Battery Holder	BH-18650-PC2	1	\$1.50	Keystone	2-cell holder with leads
Solar Panel	SP-6V2W	1	\$12.00	Voltaic	6V 2W with junction box

Component	Part Number	Qty	Unit Cost	Supplier	Notes
Charge Controller	TP4056-MICRO	1	\$1.20	Generic	USB-C input, protection
Voltage Regulator	AMS1117-3.3	1	\$0.30	AMS	800mA LDO
Enclosure	IP65-150x110x70	1	\$8.50	Bud Industries	ABS plastic, clear lid
PCB	Custom 2-layer	1	\$3.00	JLCPCB	50x40mm, HASL finish
Connectors	JST-XH 2.54mm	4	\$0.25	JST	Battery, sensor connections
Mounting Hardware	M4 bolts, nuts	1	\$2.00	McMaster	Stainless steel
Antenna	PCB 2.4GHz	1	\$1.50	Johanson	Ceramic chip antenna
Capacitors	Various	5	\$0.50	Murata	Decoupling, filtering
Resistors	Various	8	\$0.20	Yageo	Pull-up, dividers
Total			\$46.25	Qty 100+ pricing	

Type B: Advanced AI-Powered Node

Use Case: High-traffic areas, contamination monitoring **Battery Life:** 3-6 months **Connectivity:** LoRaWAN + WiFi **Cost Target:** \$180-220

Core Components

Raspberry Pi 4 Model B (4GB)

- CPU: Quad-core ARM Cortex-A72 @ 1.5GHz
- RAM: 4GB LPDDR4
- Storage: 32GB microSD Class 10
- Connectivity: WiFi, Bluetooth, Ethernet
- Power: 5V, 3A max

Pi Camera Module v3

- Sensor: Sony IMX708, 12MP
- Resolution: 4608x2592 @ 30fps
- Lens: f/1.8, 75° FOV
- Interface: MIPI CSI-2
- Power: 3.3V, 250mA

Load Cell System

- Sensor: 50kg aluminum single point
- ADC: HX711 24-bit
- Accuracy: ±0.1% full scale

- Interface: SPI
- Calibration: Software adjustable

Detailed BOM

Component	Part Number	Qty	Unit Cost	Supplier	Notes
Raspberry Pi 4B	RPI4-MODBP-4GB	1	\$75.00	Raspberry Pi	4GB RAM version
Pi Camera v3	RPI-CAM-V3	1	\$25.00	Raspberry Pi	12MP autofocus
Load Cell	TAL220-50kg	1	\$12.00	HTC Sensor	Aluminum, IP65
Load Cell Amp	HX711	1	\$3.50	Avia Semi	24-bit ADC
Ultrasonic Array	HC-SR04	4	\$2.80	Generic	Waterproof versions
LoRaWAN Module	RFM95W-915S2	1	\$8.50	HopeRF	915MHz, SPI interface
LiFePO4 Battery	12V-10Ah-LFP	1	\$45.00	Battle Born	Prismatic cells
Solar Panel	20W-MONO	1	\$25.00	Renogy	Monocrystalline
MPPT Controller	CN3722-10A	1	\$18.00	Consonance	10A MPPT
DC-DC Converter	LM2596S-5V	1	\$3.50	TI	5V 3A output
Enclosure	AL-200x150x100	1	\$35.00	Hammond	Aluminum, IP67
microSD Card	32GB-C10-A1	1	\$8.00	SanDisk	Industrial grade
Cooling Fan	30x30x7mm	1	\$4.00	Noctua	5V, low noise
Mounting Plate	AL-6061-T6	1	\$12.00	Custom	CNC machined
Cables & Connectors	Various	1	\$15.00	Various	Weatherproof
Total			\$292.30	Qty 50+ pricing	

Collection Vehicle Tracker

GPS & Telematics Module

Use Case: Waste collection trucks, route optimization **Power:** Vehicle 12V system **Connectivity:** GSM/LTE + GPS **Cost Target:** \$85-110

Core Components

- ESP32-WROVER-E Module
- CPU: Dual-core Xtensa LX6 @ 240MHz
 - RAM: 520KB SRAM + 8MB PSRAM
 - Flash: 16MB
 - WiFi: 802.11 b/g/n
 - Bluetooth: v4.2 BR/EDR + BLE

SIM800L GSM Module
└─ Frequency: Quad-band GSM/GPRS
└─ Data: GPRS Class 10
└─ SMS: Text and PDU mode
└─ Voice: Not required
└─ Power: 3.4V-4.4V
NEO-8M GPS Module
└─ Channels: 72 acquisition, 18 tracking
└─ Accuracy: 2.5m CEP
└─ Cold Start: 26s
└─ Hot Start: 1s
└─ Update Rate: 1-10Hz

Detailed BOM

Component	Part Number	Qty	Unit Cost	Supplier	Notes
ESP32-WROVER-E	ESP32-WROVER-E-N16R8	1	\$8.50	Espressif	16MB Flash, 8MB PSRAM
GSM Module	SIM800L-EVB	1	\$8.00	SIMCom	Quad-band GSM/GPRS
GPS Module	NEO-8M-001	1	\$12.00	u-blox	High sensitivity
Accelerometer	MPU6050	1	\$2.50	InvenSense	6-axis IMU
OBD-II Interface	ELM327-UART	1	\$15.00	ELM Electronics	UART interface
Power Supply	LM2596S-ADJ	1	\$2.50	TI	Adjustable buck converter
SIM Card Holder	NANO-SIM-001	1	\$1.50	Molex	Push-push type
Enclosure	ABS-100x80x30	1	\$6.00	Bud Industries	Automotive grade
GPS Antenna	GPS-ANT-25dB	1	\$4.00	Taoglas	25dB gain, magnetic
GSM Antenna	GSM-ANT-2dB	1	\$3.50	Taoglas	2dBi gain, adhesive
Wiring Harness	OBD-HARNESS	1	\$8.00	Custom	16-pin to terminals
Fuses & Protection	Various	1	\$3.00	Littelfuse	Automotive grade
PCB	4-layer 80x60mm	1	\$5.00	JLCPCB	Impedance controlled
Assembly & Test	Labor	1	\$12.00	Contract	Final assembly
Total			\$92.50		Qty 100+ pricing

Power Consumption Analysis

Type A Node (Basic)

Active Mode (10 seconds/hour):

- ESP32-S3: $160\text{mA} @ 3.3\text{V} = 528\text{mW}$
- HC-SR04: $15\text{mA} @ 5\text{V} = 75\text{mW}$
- Total Active: 603mW

Sleep Mode (3590 seconds/hour):

- ESP32-S3: $10\mu\text{A} @ 3.3\text{V} = 33\mu\text{W}$
- HC-SR04: 0mA (powered down)
- Total Sleep: $33\mu\text{W}$

Daily Energy Consumption:

- Active: $603\text{mW} \times (240\text{s}/86400\text{s}) = 1.67\text{Wh}$
- Sleep: $33\mu\text{W} \times (86160\text{s}/86400\text{s}) = 0.79\text{Wh}$
- Total: 2.46Wh/day

Battery Capacity: $2 \times 3000\text{mAh} \times 3.7\text{V} = 22.2\text{Wh}$

Battery Life: $22.2\text{Wh} \div 2.46\text{Wh/day} = 9.0 \text{ days}$

With Solar: $2\text{W} \times 4 \text{ hours} = 8\text{Wh/day}$

Net Consumption: $2.46 - 8 = -5.54\text{Wh/day}$ (surplus)

Type B Node (Advanced)

Active Mode (AI processing 5 minutes/hour):

- Raspberry Pi 4: $2.5\text{A} @ 5\text{V} = 12.5\text{W}$
- Pi Camera: $250\text{mA} @ 3.3\text{V} = 825\text{mW}$
- Load Cell: $10\text{mA} @ 5\text{V} = 50\text{mW}$
- LoRaWAN: $120\text{mA} @ 3.3\text{V} = 396\text{mW}$
- Total Active: 13.77W

Idle Mode (55 minutes/hour):

- Raspberry Pi 4: $600\text{mA} @ 5\text{V} = 3\text{W}$
- Pi Camera: 0mA (powered down)
- Load Cell: $1\text{mA} @ 5\text{V} = 5\text{mW}$
- LoRaWAN: $1.5\text{mA} @ 3.3\text{V} = 5\text{mW}$
- Total Idle: 3.01W

Daily Energy Consumption:

- Active: $13.77\text{W} \times (2\text{h}/24\text{h}) = 1.15\text{Wh}$
- Idle: $3.01\text{W} \times (22\text{h}/24\text{h}) = 2.76\text{Wh}$
- Total: 3.91Wh/day

Battery Capacity: $12\text{V} \times 10\text{Ah} = 120\text{Wh}$

Battery Life: $120\text{Wh} \div 3.91\text{Wh/day} = 30.7 \text{ days}$

With Solar: 20W × 5 hours = 100Wh/day
Net Consumption: 3.91 - 100 = -96.09Wh/day (large surplus)

Environmental Specifications

Operating Conditions

- **Temperature:** -20°C to +60°C
- **Humidity:** 0-95% RH, non-condensing
- **IP Rating:** IP65 minimum (dust-tight, water resistant)
- **UV Resistance:** UV stabilized materials
- **Vibration:** IEC 60068-2-6 (10-500Hz, 2g)

Compliance Standards

- **FCC Part 15:** Radio frequency emissions
- **CE Marking:** European conformity
- **RoHS:** Restriction of hazardous substances
- **WEEE:** Waste electrical equipment directive
- **UL Listed:** Safety certification for North America

Manufacturing & Assembly

PCB Specifications

Type A Node PCB:

└─ Size: 50mm × 40mm

└─ Layers: 2 (signal + ground)

└─ Thickness: 1.6mm

└─ Copper: 1oz (35µm)

└─ Finish: HASL lead-free

└─ Solder Mask: Green

└─ Silkscreen: White

└─ Via: 0.2mm minimum

Type B Node PCB:

└─ Size: 80mm × 60mm

└─ Layers: 4 (signal, power, ground, signal)

└─ Thickness: 1.6mm

└─ Copper: 2oz (70µm)

└─ Finish: ENIG (gold)

└─ Impedance: 50Ω ±10%

└─ Via: 0.15mm minimum

Assembly Process

1. **SMT Placement:** Pick-and-place for surface mount components
2. **Reflow Soldering:** Lead-free SAC305 solder paste

3. **Through-Hole:** Wave soldering for connectors
4. **Testing:** In-circuit test (ICT) + functional test
5. **Programming:** Firmware flash and calibration
6. **Enclosure:** Final assembly with gaskets and seals
7. **QC:** Final inspection and burn-in test

Quality Control

- **Incoming Inspection:** Component verification
- **Process Control:** SPC monitoring of assembly
- **Functional Test:** 100% end-of-line testing
- **Environmental Test:** Sample testing per IEC standards
- **Reliability:** MTBF > 50,000 hours target